



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Chung Liu et al.

Serial No.: 09/945,432

Filed: September 4, 2001

Group Art Unit: 2812

Examiner: Nguyen, Ha T.

Confirmation No.: 2709

For: Novel Mesh Pad Structure to
Eliminate IMD Crack on Pad

I hereby certify that this correspondence is being deposited
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Date

Cheryl L. Powell

TRANSMITTAL LETTER

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed herewith is an Associate Power Of Attorney, Change of
Correspondence Address, Issue Fee Transmittal and Acknowledgment Postcard for the
above-captioned U.S. patent application.

DATE: August 12, 2004

Respectfully submitted,

Paul A. Schwarz 55,044 / For
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